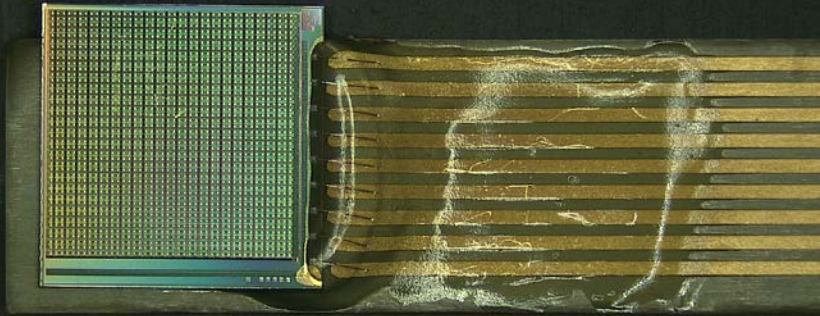
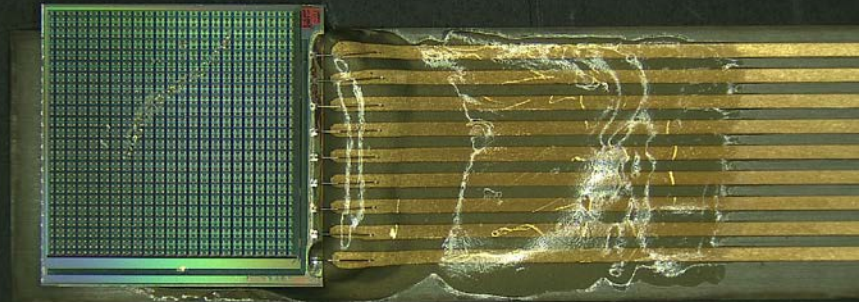


Bonded e-chips

A1

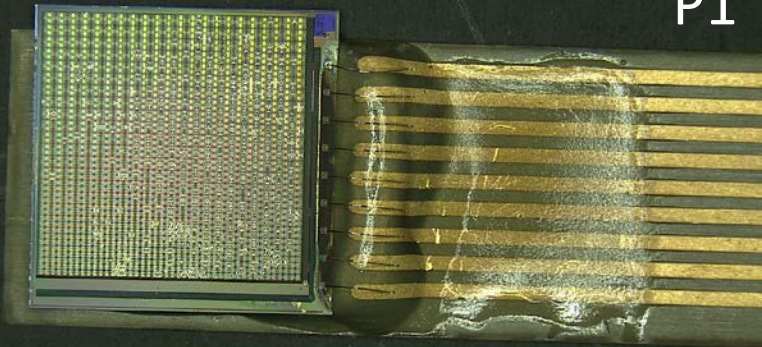


A2

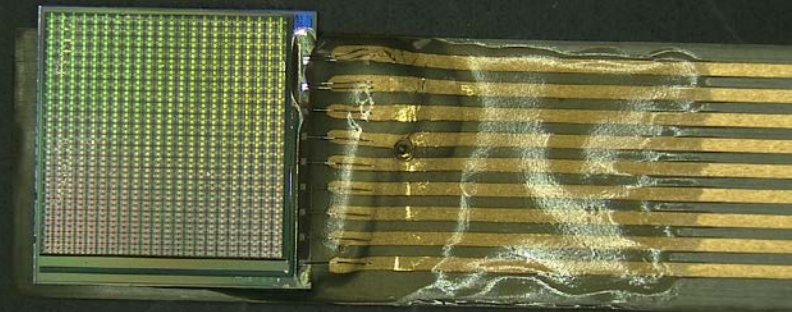


25,40 μm Au electrodes

P1

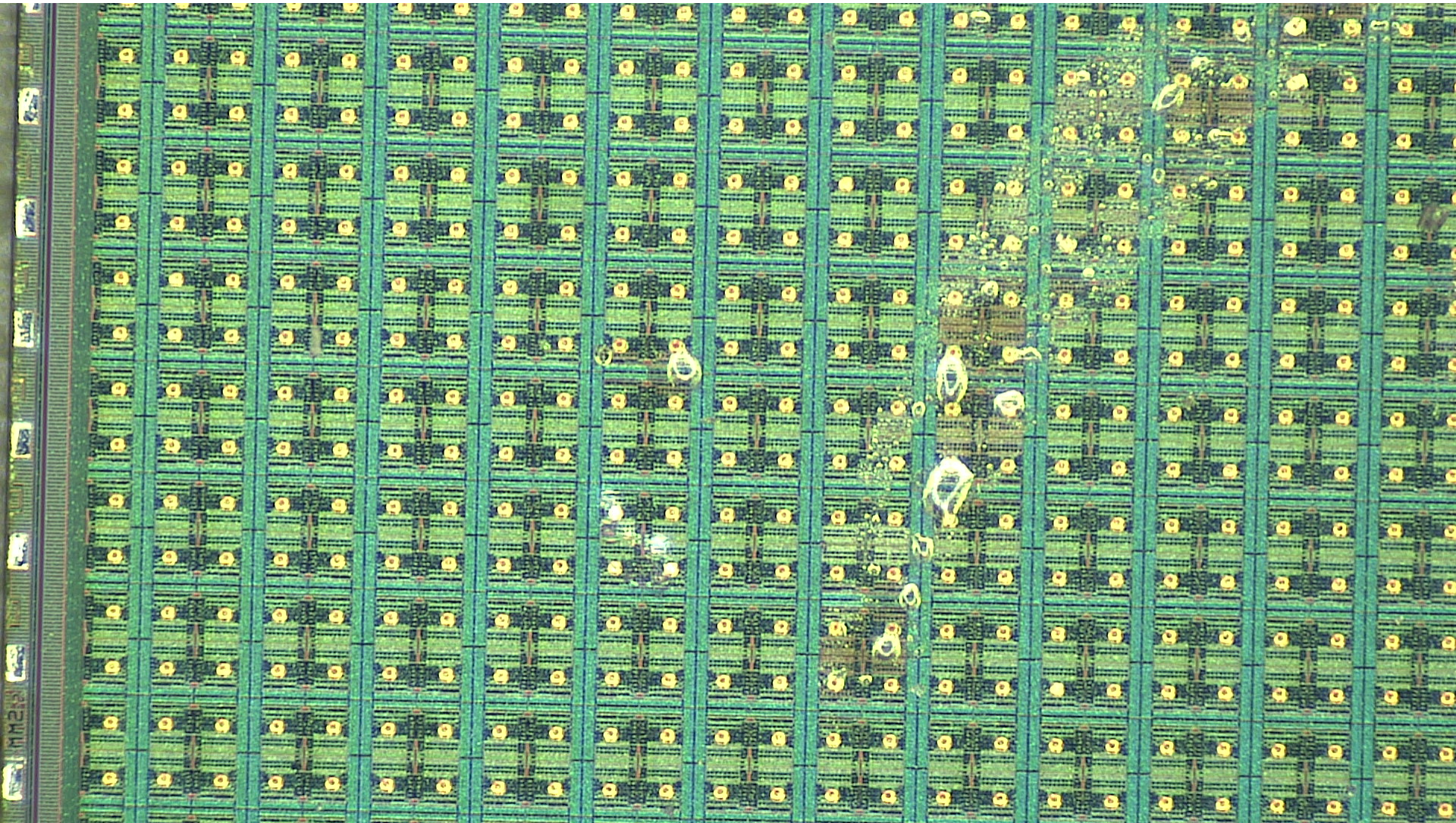


P2



90 μm Pt electrodes

Something (encapsulant?) on A2



Positioning the chip

Kapton
Chip

Kapton will start
to bend ~here



Kapton(s) of the present and future

